

View Online at https://aerobasegroup.com/nsn/5910-01-227-4616

Body Style: Chip type **Reliability Indicator:** Established **Reliability Failure Rate Level In Percent:** 0.0100 **Terminal Length:** 0.015 inches **Body Length:** 0.110 inches **Body Width:** 0.110 inches **Body Height:** Between 0.030 inches and 0.102 inches Schematic Diagram Designator: No common or grounded electrode (s) Insulation Resistance At Maximum Operating Temp: 100000.0 megohms **Capacitance Value Per Section:** 15.000 picofarads single section Nonderated Operating Temp: Between -55.0 degrees celsius and 125.0 degrees celsius Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius: 0.0 single section Nonderated Continuous Voltage Rating And Type Per Section: 500.0 dc single section **Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:** -30.0/+30.0 single section **Tolerance Range Per Section:** -2.00/+2.00 percent single section **Case Material:** Ceramic Insulation Resistance At Reference Temp: 1000000.0 megohms **Terminal Surface Treatment:** Palladium and silver **Precious Material And Location:** Terminal surfaces palladium and terminal surfaces silver **Test Data Document:** 81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).

Terminal Type And Quantity:

2 bonding pad



Specification Data:

81349-mil-c-55681/4 government specification

Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

No

Fiig:

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